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U.S. Patent And Trademark Office

To the Honorable Commissioner For Patents: Please record the attached original documents or copy thereof:

1. Name of conveying party(ies):  
Alireza Shahdoost Moghadam and Vamsi Mohan Velidandla  
Additional name(s) of conveying party(ies) attached?  
 Yes  No

2. Name and address of receiving party(ies):  
Name: KLA-Tencor Technologies  
Internal Address:  
  
Street Address: One Technology Drive  
  
City: Milpitas  
State: CA Zip: 95035  
Additional name(s) & address(es) attached?  
 Yes  No

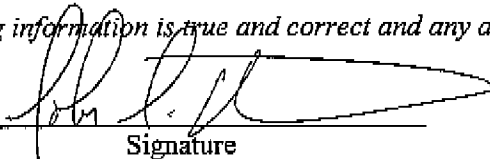
3. Nature of Conveyance:  
 Assignment  Merger  
 Security Agreement  Change of Name  
 Other: \_\_\_\_\_  
  
Execution Date: January 18, 2005

4. Application number(s) or patent number:  
If this document is being filed together with a new application, the execution date of the application is: \_\_\_\_\_  
  
A. Patent Application No.: 10/952,590  
B. Patent No.(s):  
  
Additional numbers attached?  Yes  No

5. Name and address of party to whom correspondence concerning document should be mailed:  
Name: John T. McNelis  
Internal Address: Fenwick & West LLP  
Street Address: Silicon Valley Center  
801 California Street  
City: Mountain View State: CA Zip Code: 94041

6. Total number of applications and patents involved: [1]  
7. Total fee (37 CFR 3.41): \$40.00  
 Check Enclosed  
 Fee Transmittal Enclosed  
 Charge the indicated fees to the below mentioned deposit account.  
8. Deposit Account No.: 19-2555

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9. Statement and signature:  
*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*  
John T. McNelis, Reg. No. 37,186  
Name of Person Signing  Signature 3 Feb 2005 Date

Total number of pages including cover sheet, attachments, documents: [4]

Mail documents to be recorded with required cover sheet information to: Mail Stop Assignment Recordation Services, Director of the U.S. Patent and Trademark Office, P.O. Box 1450, Alexandria, VA 22313-1450.

Case Docket No.: 20830-09026

CHI \$40.00 192555 10962690

## ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, the person(s) named below (referred to as "INVENTOR" whether singular or plural) has sold, assigned, and transferred and does hereby sell, assign, and transfer to **KLA-Tencor Technologies Corporation** a California corporation, having a place of business at **One Technology Drive, Milpitas, CA 95035**, ("ASSIGNEE"), for itself and its successors, transferees, and assignees, the following:

1. The entire worldwide right, title, and interest in all inventions and improvements ("SUBJECT MATTER") that are disclosed in the provisional application filed under 35 U.S.C. §111(b) or non-provisional application filed under 35 U.S.C. §111(a) and entitled **System and Method For Optimizing Wafer Flatness at High Rotational Speeds** ("APPLICATION"), which:

- is to be filed herewith.
- was filed on September 28, 2004, and now bears U.S. application serial number **10/952,590**.
- The APPLICATION claims priority from [a provisional/foreign application], filed on \_\_\_\_\_, now bearing [Country] application serial number \_\_\_\_\_.

2. The entire worldwide right, title, and interest in and to:  
(a) the APPLICATION; (b) all applications claiming priority from the APPLICATION; (c) all provisional, utility, divisional, continuation, substitute, renewal, reissue, and other applications related thereto which have been or may be filed in the United States or elsewhere in the world; (d) all patents (including reissues and re-examinations) which may be granted on the applications set forth in (a), (b), and (c) above; and (e) all right of priority in the APPLICATION and in any underlying provisional or foreign application, together with all rights to recover damages for infringement of provisional rights.

INVENTOR agrees that ASSIGNEE may apply for and receive patents for SUBJECT MATTER in ASSIGNEE's own name.

INVENTOR agrees to do the following, when requested, and without further consideration, in order to carry out the intent of this Assignment: (1) execute all oaths, assignments, powers of attorney, applications, and other papers necessary or desirable to fully secure to ASSIGNEE the rights, titles and interests herein conveyed; (2) communicate to ASSIGNEE all known facts relating to the SUBJECT MATTER; and (3) generally do all lawful acts that ASSIGNEE shall consider desirable for securing, maintaining, and enforcing worldwide patent protection relating to the SUBJECT MATTER and for vesting in ASSIGNEE the rights, titles, and interests herein conveyed. INVENTOR further agrees to provide any successor, assign, or legal representative of ASSIGNEE with the benefits and assistance provided to ASSIGNEE hereunder.

Title: **System And Method for Optimizing Wafer Flatness At High Rotational Speeds**  
 Filed: **September 28, 2004**  
 Application No.: **10/952,590**

INVENTOR represents that INVENTOR has the rights, titles, and interests to convey as set forth herein, and covenants with ASSIGNEE that the INVENTOR has not made and will not hereafter make any assignment, grant, mortgage, license, or other agreement affecting the rights, titles, and interests herein conveyed.

INVENTOR grants the attorney of record the power to insert on this Assignment any further identification that may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

This Assignment may be executed in one or more counterparts, each of which shall be deemed an original and all of which may be taken together as one and the same Assignment.

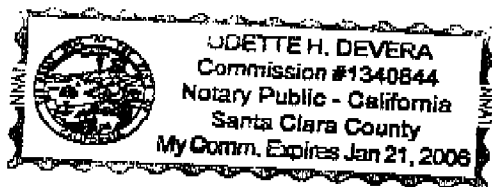
<u>Name and Signature</u>	<u>Date of Signature</u>
<i>Alireza Shahdoost Moghadam</i> Alireza Shahdoost Moghadam	<u>Jan 18, 2005</u>
State of <u>CA</u>	
County of <u>Santa Clara</u>	

On Jan 18, 2005 before me, Odette H. Devera personally appeared  
 [DATE] [NOTARY PUBLIC]

Alireza S. Moghadam personally known to me or proved to me on the basis of satisfactory  
 [INVENTOR]

evidence to be the person whose name is subscribed to the within instrument and acknowledged to me that he/she executed the same in his/her authorized capacity, and that by his/her signature on the instrument the person, or the entity upon behalf of which the person acted, executed the instrument.

Notary Seal



Odette H. Devera  
 Notary

Title: **System And Method for Optimizing Wafer Flatness At High Rotational Speeds**  
 Filed: **September 28, 2004**  
 Application No.: **10/952,590**

Name and Signature

Date of Signature

*V. Vamsi Mohan Velidandla*

*Jan 18 20 05*

Vamsi Mohan Velidandla

State of CA

County of Santa Clara

On Jan. 18, 2005 before me, Odette H. Devera personally appeared  
 [DATE] [NOTARY PUBLIC]

Vamsi M. Velidandla personally known to me or proved to me on the basis of satisfactory  
 [INVENTOR]

evidence to be the person whose name is subscribed to the within instrument and acknowledged to me that he/she executed the same in his/her authorized capacity, and that by his/her signature on the instrument the person, or the entity upon behalf of which the person acted, executed the instrument.

*Odette H. Devera*

Notary

Notary Seal

